

VAL-U-LOK

TE Internal #: 1586316-3

Pin Contact, Tin (Sn), 600 VAC, 26 – 22 AWG, .13 – .33 mm² Wire, Crimp, Phosphor Bronze, Power, -40 – 105 °C [-40 – 221 °F]

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Connectors > Contacts > Connector Contacts











Contact Type: Pin

Contact Mating Area Plating Material: Tin (Sn)

Wire Contact Termination Area Plating Material: Pre-Tin

Operating Voltage: 600 VAC

Contact Retention Within Housing: With

Features

Electrical Characteristics

Operating Voltage	600 VAC
Contact Features	
Contact Orientation	Straight
Contact Fabrication	Stamped & Formed
Mating Square Post Dimension	1.14 mm[.045 in]
Wire Contact Termination Area Plating Material Finish	Bright
Wire Contact Termination Area Plating Thickness	2.54 μm[100 μin]
Contact Type	Pin
Contact Mating Area Plating Material	Tin (Sn)
Wire Contact Termination Area Plating Material	Pre-Tin
Contact Retention Within Housing	With
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	9 A

Termination Features



Termination Method to Wire & Cable	Crimp
Product Terminates To	Wire & Cable
Mechanical Attachment	
Wire Insulation Support	Without
Dimensions	
Compatible Insulation Diameter Range	1.19 – 1.75 mm[.047 – .069 in]
Wire Size	.13 – .33 mm²
Usage Conditions	
Operating Temperature Range	-40 – 105 °C[-40 – 221 °F]
Operation/Application	
Circuit Application	Power
Industry Standards	
Compatible With Agency/Standards Products	CSA, UL
UL Flammability Rating	UL 94V-0, UL 94V-2
Packaging Features	
Packaging Quantity	500
Packaging Method	Loose Piece

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

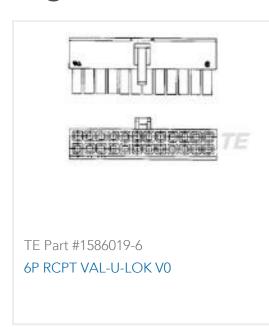


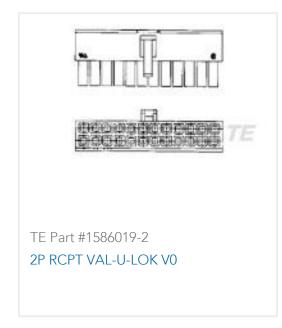


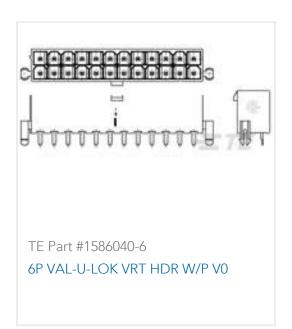


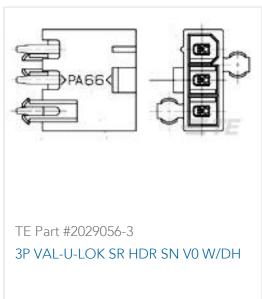
Customers Also Bought









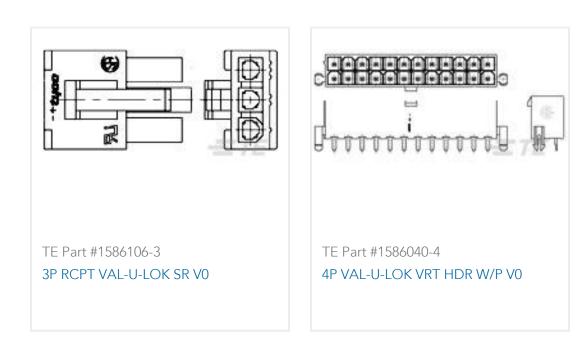












Documents

Product Drawings

VAL-U-LOK PIN PHBZ SN 26-22 LP

English

CAD Files

Customer View Model

ENG_CVM_1586316-3_A.3d_igs.zip

English

Customer View Model

ENG_CVM_1586316-3_A.3d_stp.zip

English

Customer View Model

ENG_CVM_1586316-3_A.2d_dxf.zip

English

3D PDF

3D

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

SOFT_SHELL_PIN_AND_SOCKET_CONNECTORS_CATALOG

English

Product Specifications

Application Specification

English